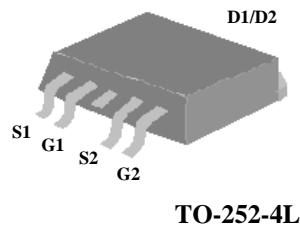




## ▼ Simple Drive Requirement

## ▼ Good Thermal Performance

## ▼ Fast Switching Performance

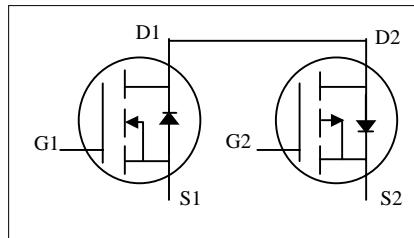


TO-252-4L

**Description**

|      |              |      |
|------|--------------|------|
| N-CH | $BV_{DSS}$   | 35V  |
|      | $R_{DS(ON)}$ | 30mΩ |
|      | $I_D$        | 15A  |
| P-CH | $BV_{DSS}$   | -35V |
|      | $R_{DS(ON)}$ | 48mΩ |
|      | $I_D$        | -12A |

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

**Absolute Maximum Ratings**

| Symbol                    | Parameter                             | Rating     |           | Units |
|---------------------------|---------------------------------------|------------|-----------|-------|
|                           |                                       | N-channel  | P-channel |       |
| $V_{DS}$                  | Drain-Source Voltage                  | 35         | -35       | V     |
| $V_{GS}$                  | Gate-Source Voltage                   | +20        | +20       | V     |
| $I_D @ T_C = 25^\circ C$  | Continuous Drain Current <sup>3</sup> | 15         | -12       | A     |
| $I_D @ T_C = 100^\circ C$ | Continuous Drain Current <sup>3</sup> | 9          | -7        | A     |
| $I_{DM}$                  | Pulsed Drain Current <sup>1</sup>     | 50         | -50       | A     |
| $P_D @ T_C = 25^\circ C$  | Total Power Dissipation               | 10.4       |           | W     |
|                           | Linear Derating Factor                | 0.083      |           | W/°C  |
| $T_{STG}$                 | Storage Temperature Range             | -55 to 150 |           | °C    |
| $T_J$                     | Operating Junction Temperature Range  | -55 to 150 |           | °C    |

**Thermal Data**

| Symbol      | Parameter   | Value | Units |
|-------------|---|-------|-------|
| $R_{thj-c}$ | Maximum Thermal Resistance, Junction-case <sup>3</sup>    | 12    | °C/W  |
| $R_{thj-a}$ | Maximum Thermal Resistance, Junction-ambient <sup>3</sup> | 110   | °C/W  |


**N-CH Electrical Characteristics @  $T_j=25^\circ\text{C}$  (unless otherwise specified)**

| Symbol                                     | Parameter  | Test Conditions   | Min. | Typ. | Max.      | Units                     |
|--|--|---|------|------|-----------|---------------------------|
| $\text{BV}_{\text{DSS}}$                   | Drain-Source Breakdown Voltage                           | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$      | 35   | -    | -         | V                         |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_j$ | Breakdown Voltage Temperature Coefficient                | Reference to $25^\circ\text{C}$ , $I_{\text{D}}=1\text{mA}$ | -    | 0.03 | -         | $\text{V}/^\circ\text{C}$ |
| $R_{\text{DS}(\text{ON})}$                 | Static Drain-Source On-Resistance <sup>2</sup>           | $V_{\text{GS}}=10\text{V}, I_{\text{D}}=8\text{A}$          | -    | -    | 30        | $\text{m}\Omega$          |
|  |  | $V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=6\text{A}$         | -    | -    | 40        | $\text{m}\Omega$          |
| $V_{\text{GS}(\text{th})}$                 | Gate Threshold Voltage                                   | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$  | 1    | -    | 3         | V                         |
| $g_{\text{fs}}$                            | Forward Transconductance                                 | $V_{\text{DS}}=10\text{V}, I_{\text{D}}=8\text{A}$          | -    | 13   | -         | S                         |
| $I_{\text{DSS}}$                           | Drain-Source Leakage Current                             | $V_{\text{DS}}=35\text{V}, V_{\text{GS}}=0\text{V}$         | -    | -    | 1         | $\text{uA}$               |
|  | Drain-Source Leakage Current ( $T_j=150^\circ\text{C}$ ) | $V_{\text{DS}}=28\text{V}, V_{\text{GS}}=0\text{V}$         | -    | -    | 25        | $\text{uA}$               |
| $I_{\text{GSS}}$                           | Gate-Source Leakage                                      | $V_{\text{GS}}=\pm 20\text{V}$                              | -    | -    | $\pm 100$ | nA                        |
| $Q_g$                                      | Total Gate Charge <sup>2</sup>                           | $I_{\text{D}}=8\text{A}$                                    | -    | 11   | 18        | nC                        |
| $Q_{\text{gs}}$                            | Gate-Source Charge                                       | $V_{\text{DS}}=28\text{V}$                                  | -    | 3    | -         | nC                        |
| $Q_{\text{gd}}$                            | Gate-Drain ("Miller") Charge                             | $V_{\text{GS}}=4.5\text{V}$                                 | -    | 6    | -         | nC                        |
| $t_{\text{d}(\text{on})}$                  | Turn-on Delay Time <sup>2</sup>                          | $V_{\text{DS}}=18\text{V}$                                  | -    | 12   | -         | ns                        |
| $t_r$                                      | Rise Time  | $I_{\text{D}}=1\text{A}$                                    | -    | 7    | -         | ns                        |
| $t_{\text{d}(\text{off})}$                 | Turn-off Delay Time                                      | $R_G=3.3\Omega, V_{\text{GS}}=10\text{V}$                   | -    | 22   | -         | ns                        |
| $t_f$                                      | Fall Time  | $R_D=18\Omega$  | -    | 6    | -         | ns                        |
| $C_{\text{iss}}$                           | Input Capacitance  | $V_{\text{GS}}=0\text{V}$                                   | -    | 830  | 1330      | pF                        |
| $C_{\text{oss}}$                           | Output Capacitance                                       | $V_{\text{DS}}=25\text{V}$                                  | -    | 150  | -         | pF                        |
| $C_{\text{rss}}$                           | Reverse Transfer Capacitance                             | f=1.0MHz  | -    | 110  | -         | pF                        |
| $R_g$                                      | Gate Resistance  | f=1.0MHz  | -    | 1.1  | 1.7       | $\Omega$                  |

**Source-Drain Diode**

| Symbol          | Parameter                          | Test Conditions                                   | Min. | Typ. | Max. | Units |
|-----------------|------------------------------------|---|------|------|------|-------|
| $V_{\text{SD}}$ | Forward On Voltage <sup>2</sup>    | $I_{\text{S}}=8\text{A}, V_{\text{GS}}=0\text{V}$ | -    | -    | 1.2  | V     |
| $t_{\text{rr}}$ | Reverse Recovery Time <sup>2</sup> | $I_{\text{S}}=8\text{A}, V_{\text{GS}}=0\text{V}$ | -    | 18   | -    | ns    |
| $Q_{\text{rr}}$ | Reverse Recovery Charge            | $dI/dt=100\text{A}/\mu\text{s}$                   | -    | 12   | -    | nC    |

**P-CH Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)**

| Symbol                                     | Parameter  | Test Conditions   | Min. | Typ.  | Max.      | Units                     |
|--|--|---|------|-------|-----------|---------------------------|
| $\text{BV}_{\text{DSS}}$                   | Drain-Source Breakdown Voltage                           | $\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=-250\mu\text{A}$            | -35  | -     | -         | V                         |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_j$ | Breakdown Voltage Temperature Coefficient                | Reference to $25^\circ\text{C}, \text{I}_D=-1\text{mA}$                 | -    | -0.03 | -         | $\text{V}/^\circ\text{C}$ |
| $\text{R}_{\text{DS(ON)}}$                 | Static Drain-Source On-Resistance <sup>2</sup>           | $\text{V}_{\text{GS}}=-10\text{V}, \text{I}_D=-6\text{A}$               | -    | -     | 48        | $\text{m}\Omega$          |
|  |  | $\text{V}_{\text{GS}}=-4.5\text{V}, \text{I}_D=-4\text{A}$              | -    | -     | 70        | $\text{m}\Omega$          |
| $\text{V}_{\text{GS(th)}}$                 | Gate Threshold Voltage                                   | $\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=-250\mu\text{A}$ | -1   | -     | -3        | V                         |
| $\text{g}_{\text{fs}}$                     | Forward Transconductance                                 | $\text{V}_{\text{DS}}=-10\text{V}, \text{I}_D=-6\text{A}$               | -    | 10    | -         | S                         |
| $\text{I}_{\text{DSS}}$                    | Drain-Source Leakage Current                             | $\text{V}_{\text{DS}}=-35\text{V}, \text{V}_{\text{GS}}=0\text{V}$      | -    | -     | -1        | $\text{uA}$               |
|  | Drain-Source Leakage Current ( $T_j=150^\circ\text{C}$ ) | $\text{V}_{\text{DS}}=-28\text{V}, \text{V}_{\text{GS}}=0\text{V}$      | -    | -     | -25       | $\text{uA}$               |
| $\text{I}_{\text{GSS}}$                    | Gate-Source Leakage                                      | $\text{V}_{\text{GS}}=\pm 20\text{V}$                                   | -    | -     | $\pm 100$ | $\text{nA}$               |
| $\text{Q}_g$                               | Total Gate Charge <sup>2</sup>                           | $\text{I}_D=-6\text{A}$   | -    | 10    | 19        | $\text{nC}$               |
| $\text{Q}_{\text{gs}}$                     | Gate-Source Charge                                       | $\text{V}_{\text{DS}}=-28\text{V}$                                      | -    | 2     | -         | $\text{nC}$               |
| $\text{Q}_{\text{gd}}$                     | Gate-Drain ("Miller") Charge                             | $\text{V}_{\text{GS}}=-4.5\text{V}$                                     | -    | 6     | -         | $\text{nC}$               |
| $t_{\text{d(on)}}$                         | Turn-on Delay Time <sup>2</sup>                          | $\text{V}_{\text{DS}}=-18\text{V}$                                      | -    | 10    | -         | ns                        |
| $t_r$                                      | Rise Time  | $\text{I}_D=-1\text{A}$   | -    | 6     | -         | ns                        |
| $t_{\text{d(off)}}$                        | Turn-off Delay Time                                      | $\text{R}_G=3.3\Omega, \text{V}_{\text{GS}}=-10\text{V}$                | -    | 26    | -         | ns                        |
| $t_f$                                      | Fall Time  | $\text{R}_D=18\Omega$   | -    | 7     | -         | ns                        |
| $C_{\text{iss}}$                           | Input Capacitance  | $\text{V}_{\text{GS}}=0\text{V}$  | -    | 690   | 1100      | $\text{pF}$               |
| $C_{\text{oss}}$                           | Output Capacitance                                       | $\text{V}_{\text{DS}}=-25\text{V}$                                      | -    | 165   | -         | $\text{pF}$               |
| $C_{\text{rss}}$                           | Reverse Transfer Capacitance                             | f=1.0MHz  | -    | 130   | -         | $\text{pF}$               |
| $\text{R}_g$                               | Gate Resistance  | f=1.0MHz  | -    | 5     | 7.5       | $\Omega$                  |

**Source-Drain Diode**

| Symbol                 | Parameter                          | Test Conditions   | Min. | Typ. | Max. | Units       |
|------------------------|------------------------------------|---|------|------|------|-------------|
| $\text{V}_{\text{SD}}$ | Forward On Voltage <sup>2</sup>    | $\text{I}_S=-6\text{A}, \text{V}_{\text{GS}}=0\text{V}$ | -    | -    | -1.2 | V           |
| $t_{\text{rr}}$        | Reverse Recovery Time <sup>2</sup> | $\text{I}_S=-6\text{A}, \text{V}_{\text{GS}}=0\text{V}$ | -    | 20   | -    | ns          |
| $\text{Q}_{\text{rr}}$ | Reverse Recovery Charge            | dl/dt=-100A/ $\mu\text{s}$                              | -    | 12   | -    | $\text{nC}$ |

**Notes:**

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
- 3.N-CH , P-CH are same .

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

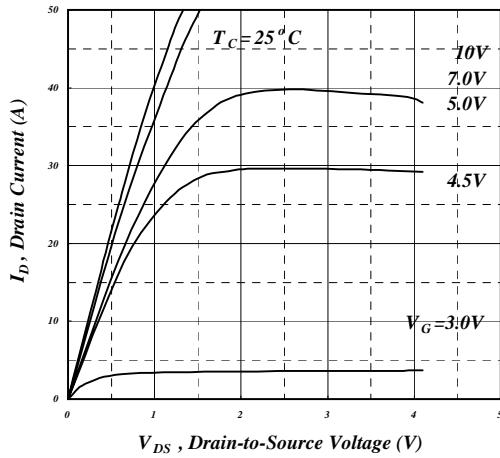
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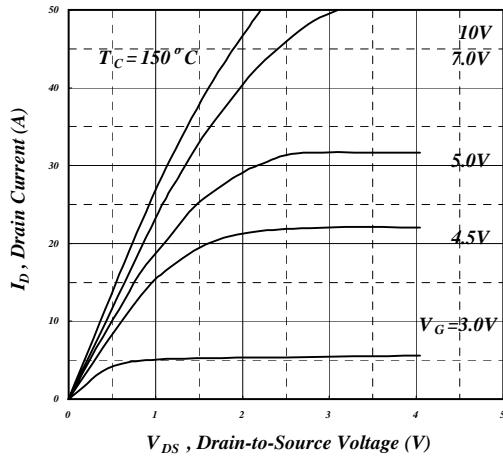
# AP4511GH



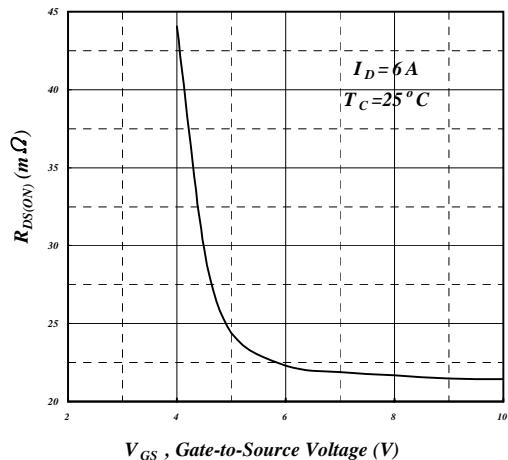
## N-Channel



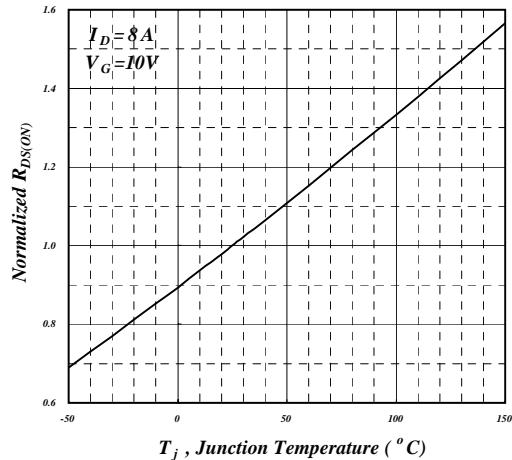
**Fig 1. Typical Output Characteristics**



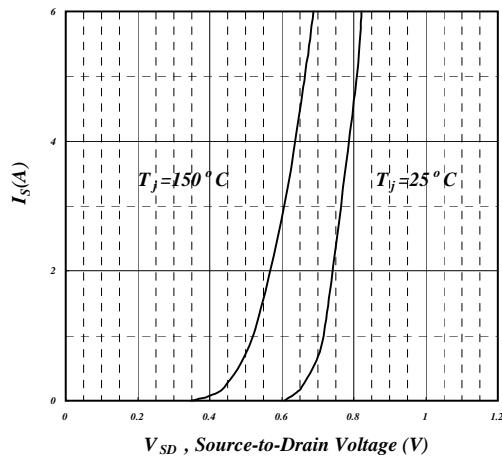
**Fig 2. Typical Output Characteristics**



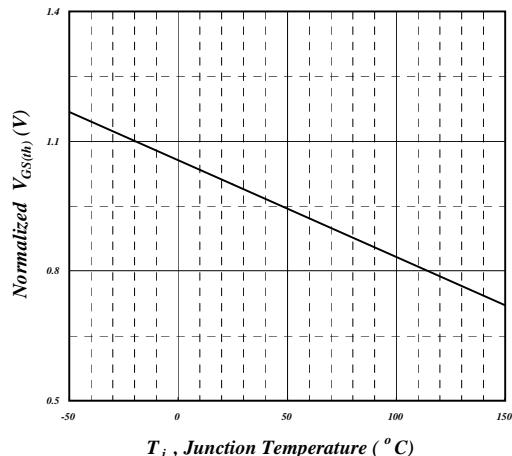
**Fig 3. On-Resistance v.s. Gate Voltage**



**Fig 4. Normalized On-Resistance v.s. Junction Temperature**



**Fig 5. Forward Characteristic of Reverse Diode**



**Fig 6. Gate Threshold Voltage v.s. Junction Temperature**



## N-Channel

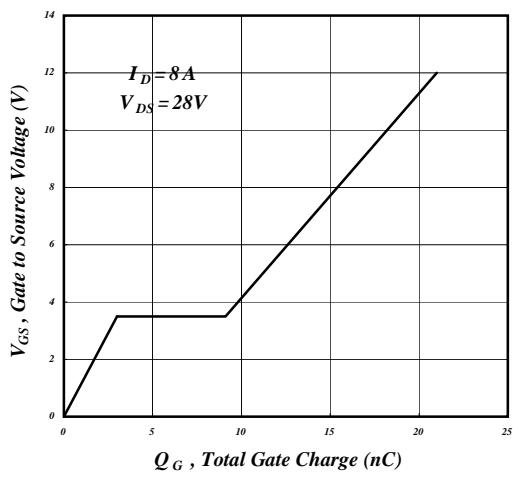


Fig 7. Gate Charge Characteristics

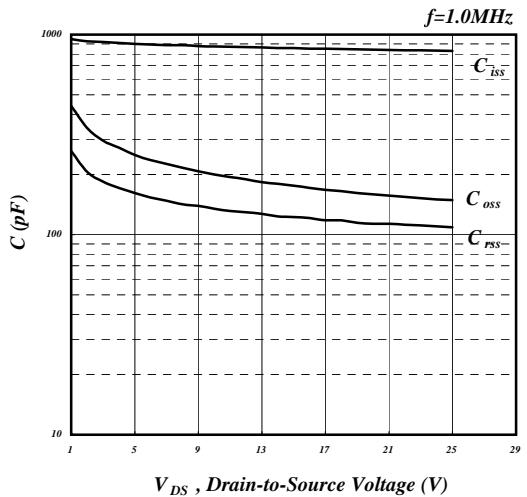


Fig 8. Typical Capacitance Characteristics

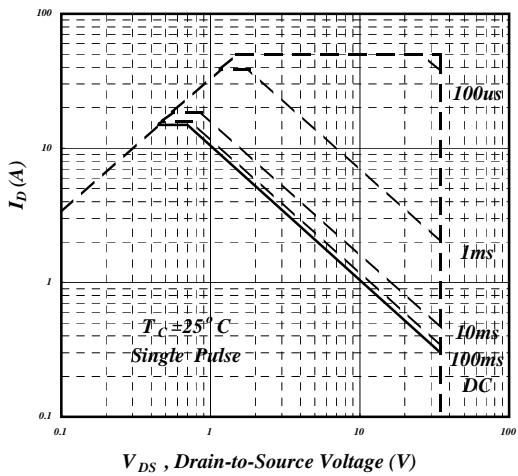


Fig 9. Maximum Safe Operating Area

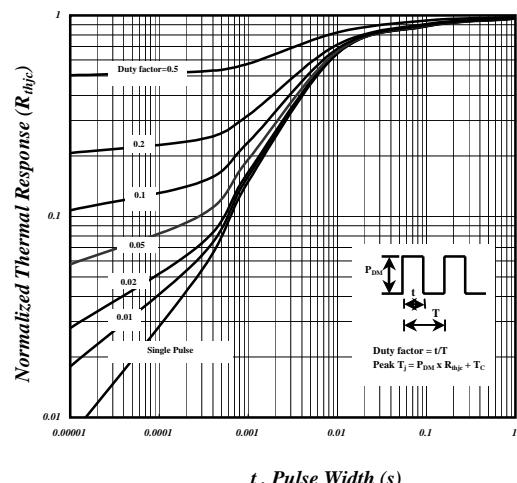


Fig 10. Effective Transient Thermal Impedance

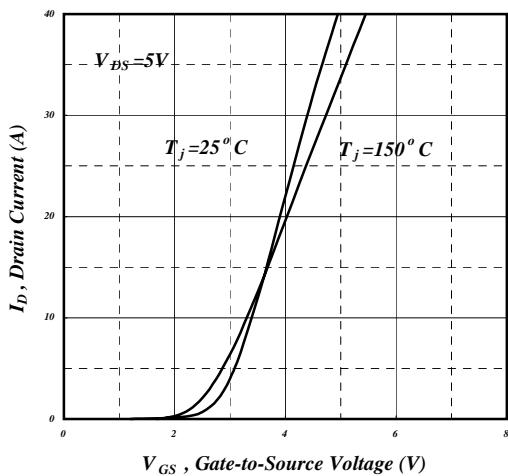


Fig 11. Transfer Characteristics

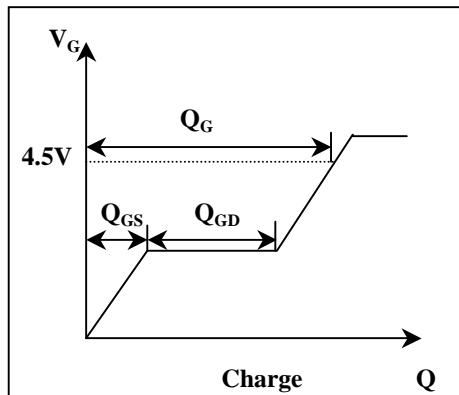
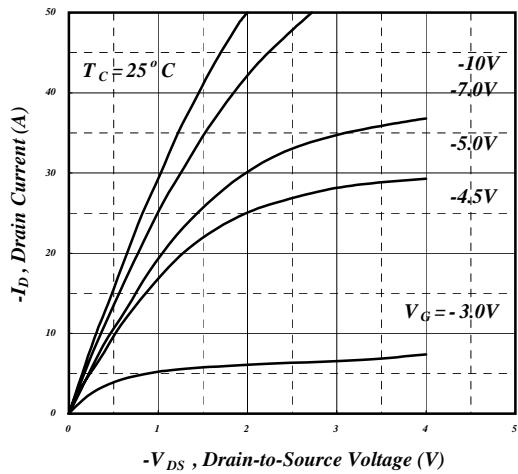


Fig 12. Gate Charge Waveform

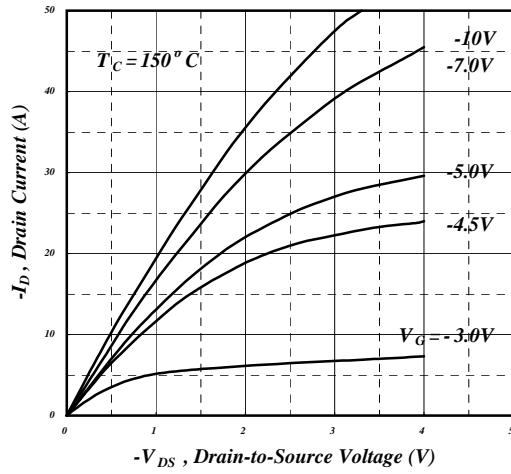
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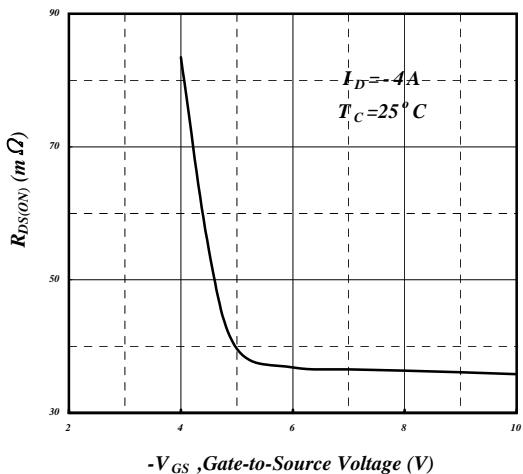
P-Channel



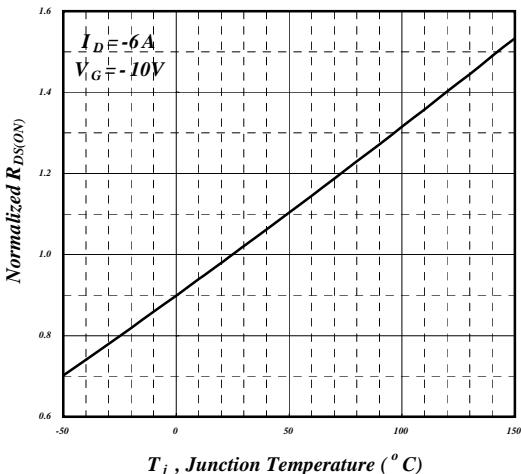
**Fig 1. Typical Output Characteristics**



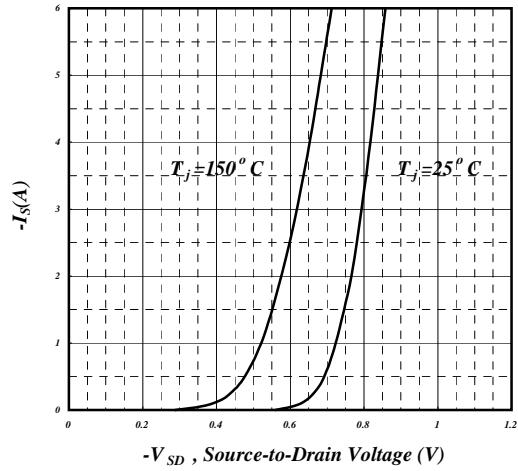
**Fig 2. Typical Output Characteristics**



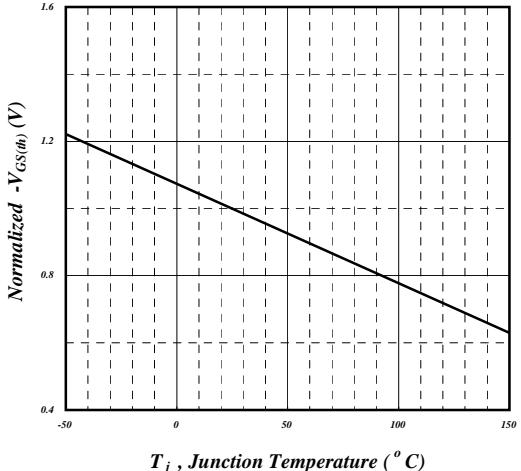
**Fig 3. On-Resistance v.s. Gate Voltage**



**Fig 4. Normalized On-Resistance v.s. Junction Temperature**



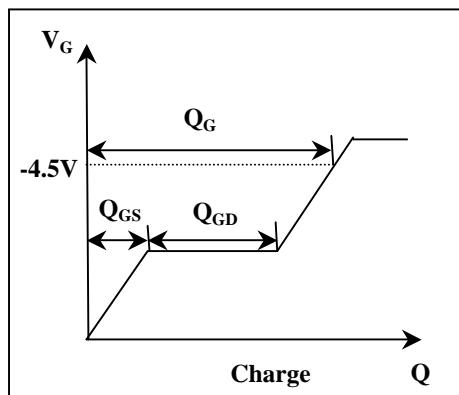
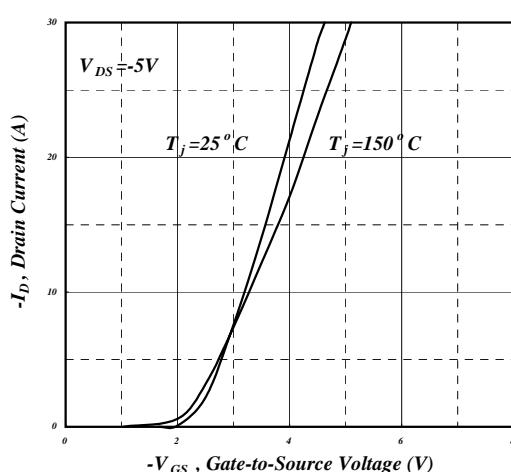
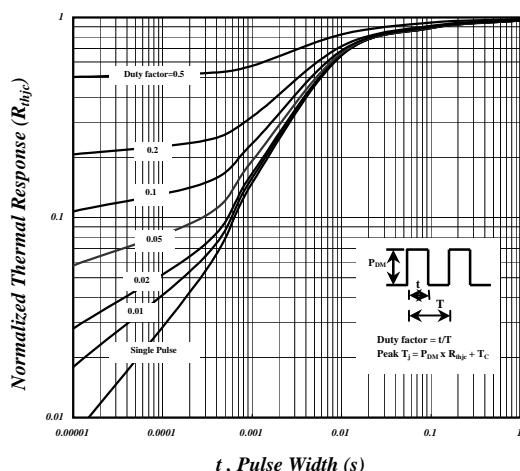
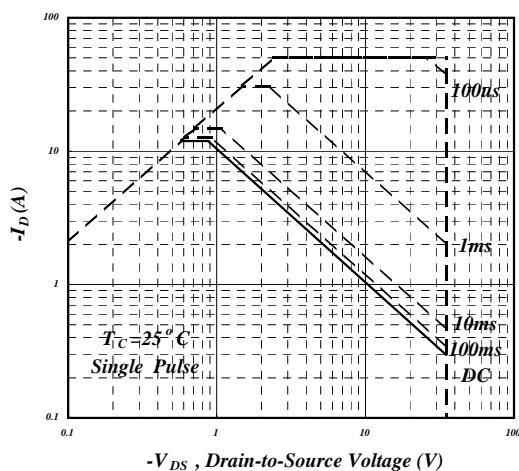
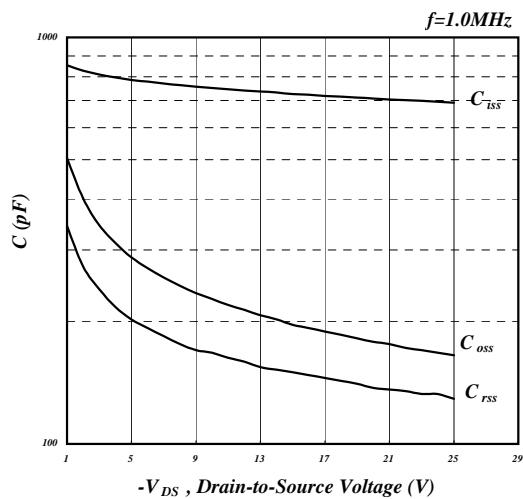
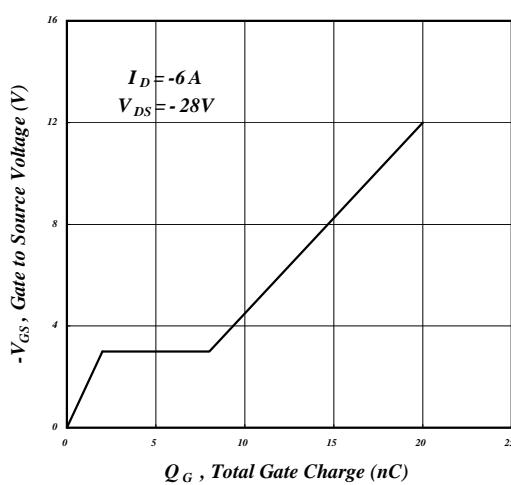
**Fig 5. Forward Characteristic of Reverse Diode**



**Fig 6. Gate Threshold Voltage v.s. Junction Temperature**



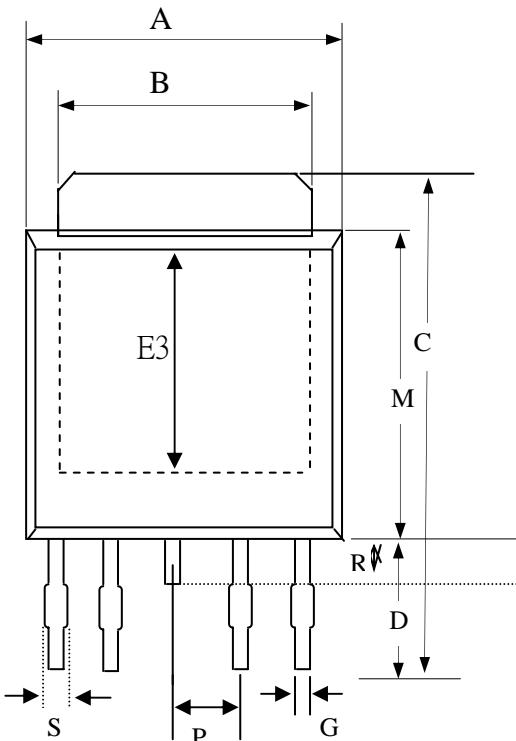
## P-Channel





ADVANCED POWER ELECTRONICS CORP.

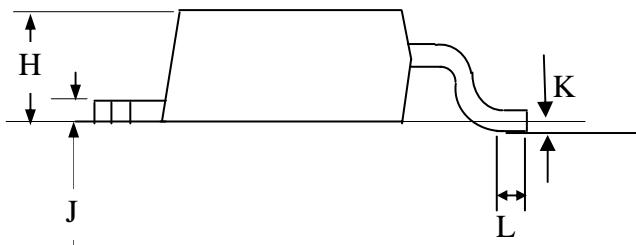
## Package Outline : TO-252(4L)



| SYMBOLS | Millimeters |       |       |
|---------|-------------|-------|-------|
|         | MIN         | NOM   | MAX   |
| A       | 6.40        | 6.6   | 6.80  |
| B       | 5.2         | 5.35  | 5.50  |
| C       | 9.40        | 9.80  | 10.20 |
| D       | 2.40        | 2.70  | 3.00  |
| P       | 1.27 REF.   |       |       |
| S       | 0.50        | 0.65  | 0.80  |
| E3      | 3.50        | 4.00  | 4.50  |
| R       | 0.80        | 1.00  | 1.20  |
| G       | 0.40        | 0.50  | 0.60  |
| H       | 2.20        | 2.30  | 2.40  |
| J       | 0.45        | 0.50  | 0.55  |
| K       | 0.00        | 0.075 | 0.15  |
| L       | 0.90        | 1.20  | 1.50  |
| M       | 5.40        | 5.60  | 5.80  |

1. All Dimensions Are in Millimeters.

2. Dimension Does Not Include Mold Protrusions.



## Part Marking Information & Packing : TO-252(4L)

